

Data sheet TS-MT/340/21 Jun 22

## 5SEE 0540T1830

60Pak rectifier diode / phase control thyristor module

- $V_{DRM}, V_{RRM} = 1800\text{ V}$
- $I_{TAVm} = 522\text{ A}$
- $I_{TSM} = 14000\text{ A}$
- $V_{T0} = 0.867\text{ V}$
- $r_T = 0.420\text{ m}\Omega$
- Insulated baseplate by AlN ceramic
- Precision pressure contacts for high reliability
- Industry standard housing



### Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	Min.	Max.	Unit
Repetitive peak off-state and reverse voltage	$V_{DRM}, V_{RRM}$	$T_j = -40 \div 135\text{ }^\circ\text{C}$ <sup>2)</sup>		1800	V
Peak off-state current	$I_{DM}$	$V_D = V_{DRM}$		100	mA
Peak reverse current	$I_{RM}$	$V_R = V_{RRM}$		100	mA
Average on-state current	$I_{TAVm}$	half sine waveform, $f = 50\text{ Hz}$	$T_c = 70\text{ }^\circ\text{C}$	630	A
			$T_c = 85\text{ }^\circ\text{C}$	522	A
			$T_c = 100\text{ }^\circ\text{C}$	401	A
RMS on-state current	$I_{TRMS}$	half sine waveform, $f = 50\text{ Hz}$	$T_c = 70\text{ }^\circ\text{C}$	989	A
			$T_c = 85\text{ }^\circ\text{C}$	821	A
			$T_c = 100\text{ }^\circ\text{C}$	631	A
Non repetitive peak surge current	$I_{TSM}$	half sine pulse, $V_D = V_R = 0\text{ V}$	$t_p = 8.3\text{ ms}$	15000	A
			$t_p = 10\text{ ms}$	14000	A
Limiting load integral	$I^2t$	half sine pulse, $V_D = V_R = 0\text{ V}$	$t_p = 8.3\text{ ms}$	928000	$\text{A}^2\text{s}$
			$t_p = 10\text{ ms}$	980000	$\text{A}^2\text{s}$
Critical rate of rise of on-state current	$(di_T/dt)_{cr}$	$I_T = I_{TAVm}$ , half sine waveform, $f = 50\text{ Hz}$ , $V_D = 2/3 V_{DRM}$ , $I_{GM} = 2\text{ A}$ , $t_r = 0.3\text{ }\mu\text{s}$		200	$\text{A}/\mu\text{s}$
Critical rate of rise of off-state voltage	$(dv_D/dt)_{cr}$	$V_D = 2/3 V_{DRM}$		1000	$\text{V}/\mu\text{s}$
Isolation voltage	$V_{isol}$	RMS (base – terminals), sine waveform, $f = 50\text{ Hz}$ , $T_j = 25\text{ }^\circ\text{C}$ , $t = 1\text{ min}$		3600	V
Operating temperature range	$T_{jmin} - T_{jmax}$		-40	135	$^\circ\text{C}$
Storage temperature range	$T_{STG}$		-40	125	$^\circ\text{C}$

Unless otherwise specified  $T_j = 135\text{ }^\circ\text{C}$

<sup>1)</sup> Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747

<sup>2)</sup> De-rating factor of 0.13%  $V_{RRM}$  or  $V_{DRM}$  per  $^\circ\text{C}$  is applicable for  $T_j$  below  $25\text{ }^\circ\text{C}$

**Maximum rated values <sup>1)</sup>**

Parameter	Symbol	Conditions	Min.	Max.	Unit
Maximum average gate power losses	$P_{GAVm}$			3	W
Peak gate current	$I_{FGM}$			10	A
Peak gate voltage	$V_{FGM}$			12	V
Reverse peak gate voltage	$V_{RGM}$			10	V

Unless otherwise specified  $T_j = 135\text{ °C}$

<sup>1)</sup> Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747

**Characteristic values**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Threshold voltage	$V_{T0}$				0.867	V
Slope resistance	$r_T$	$I_{T1} = 848\text{ A}$ , $I_{T2} = 2545\text{ A}$			0.420	m $\Omega$
Maximum peak on-state voltage	$V_{TM}$		$I_{TM} = 1\ 000\text{ A}$		1.290	V
			$I_{TM} = 1\ 500\text{ A}$		1.520	V
Holding current	$I_H$		$T_j = 25\text{ °C}$	120		mA
			$T_j = 135\text{ °C}$	100		mA
Latching current	$I_L$		$T_j = 25\text{ °C}$	700		mA
			$T_j = 135\text{ °C}$	400		mA
Gate trigger voltage	$V_{GT}$	$V_D = 12\text{ V}$ , $I_T = 4\text{ A}$	$T_j = -40\text{ °C}$		4	V
			$T_j = 25\text{ °C}$		3	V
			$T_j = 135\text{ °C}$	0.25	2	V
Gate trigger current	$I_{GT}$	$V_D = 12\text{ V}$ , $I_T = 4\text{ A}$	$T_j = -40\text{ °C}$		1000	mA
			$T_j = 25\text{ °C}$		500	mA
			$T_j = 135\text{ °C}$	10	300	mA
Delay time	$t_{gd}$	$T_j = 25\text{ °C}$ , $V_D = 0.4\ V_{DRM}$ , $I_{TM} = I_{TAVm}$ , $I_{GM} = 2\text{ A}$ , $t_r = 0.3\ \mu\text{s}$			2.0	$\mu\text{s}$
Turn-off time	$t_q$	$I_T = 1\ 000\text{ A}$ , $di_T/dt = -10\text{ A}/\mu\text{s}$ , $V_R = 100\text{ V}$ , $V_D = 2/3\ V_{DRM}$ , $dv_D/dt = 50\text{ V}/\mu\text{s}$		250		$\mu\text{s}$
Recovered charge	$Q_{rr}$	the same conditions as at $t_q$		2000		$\mu\text{C}$
Reverse recovery maximum current	$I_{rRM}$	the same conditions as at $t_q$		180		A

Unless otherwise specified  $T_j = 135\text{ °C}$

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## Mechanical properties

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dimensions	L x W x H	Typical		150 x 60 x 52		mm
Mass	m			1.4		kg
Acceleration resistance	a				50	m/s <sup>2</sup>
Mounting torques	M <sub>s</sub>	Mounting torque (base - heatsink), M6 screws	5	6	7	Nm
	M <sub>t</sub>	Mounting torque (main terminals), M10 screws	10	12	14	Nm
UL recognized		file no. E500543				

## Electrical configuration, mechanical drawing

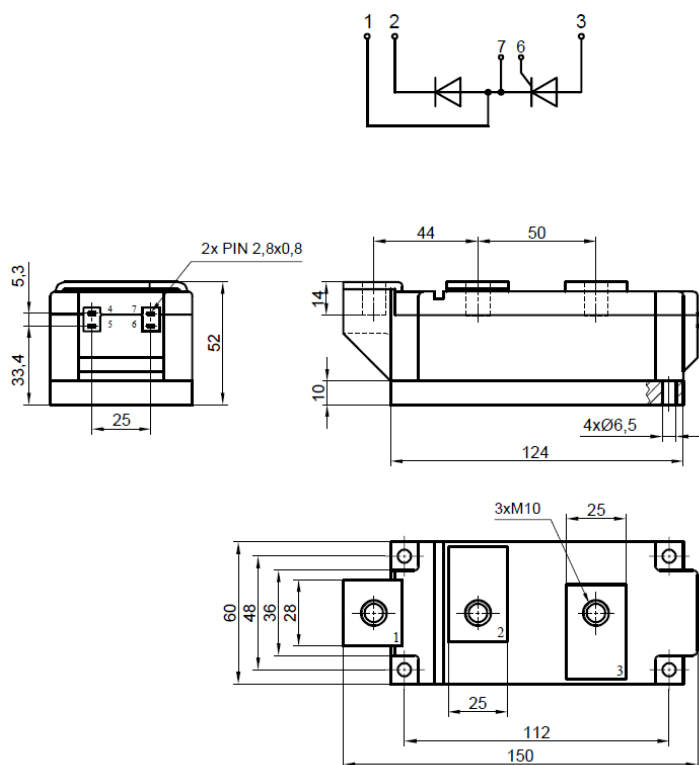


Fig. 1 Case

Note: all dimensions are shown in millimeters

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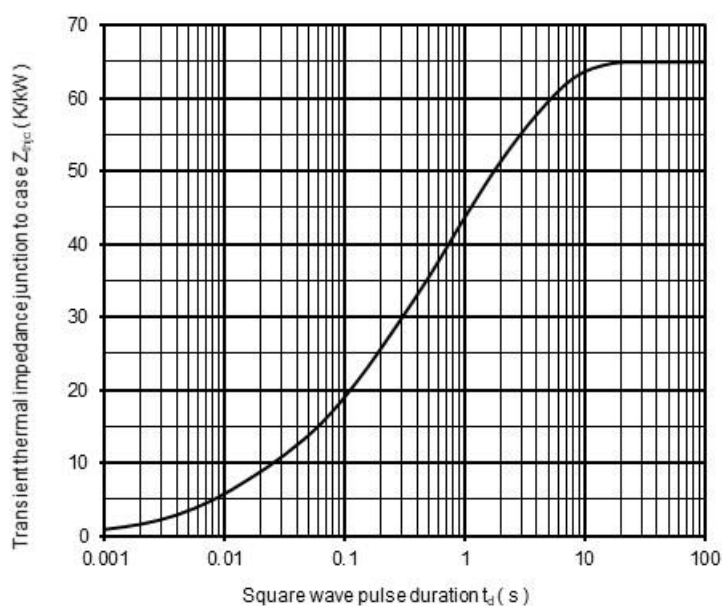
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## Thermal properties

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Thermal resistance junction to case	$R_{thjc}$	per arm			65.0	K/kW
		per module			32.5	K/kW
Thermal resistance case to heatsink	$R_{thch}$	per arm			20.0	K/kW
		per module			10.0	K/kW

Analytical function for transient thermal impedance

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$



i	1	2	3	4
$\tau_i$ (s)	3.40	0.60	0.10	0.01
$R_i$ (K/kW)	23.00	22.00	13.70	6.30

Correction for periodic waveforms

180°	sine	3.0	K/kW
120°	sine	4.7	K/kW
60°	sine	7.0	K/kW
180°	rectangular	4.8	K/kW
120°	rectangular	7.4	K/kW
60°	rectangular	12.0	K/kW

Fig. 2 Dependence transient thermal impedance junction to case on square pulse

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**On-state and surge characteristics**

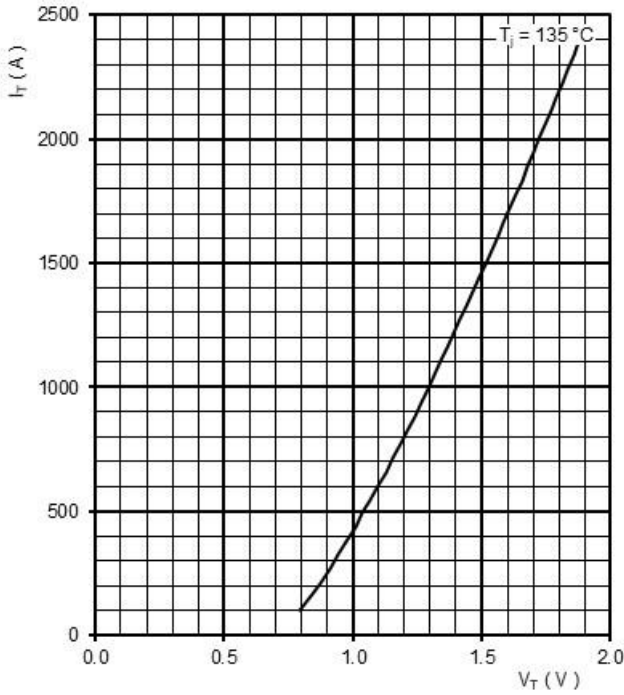


Fig. 3 Maximum on-state characteristics

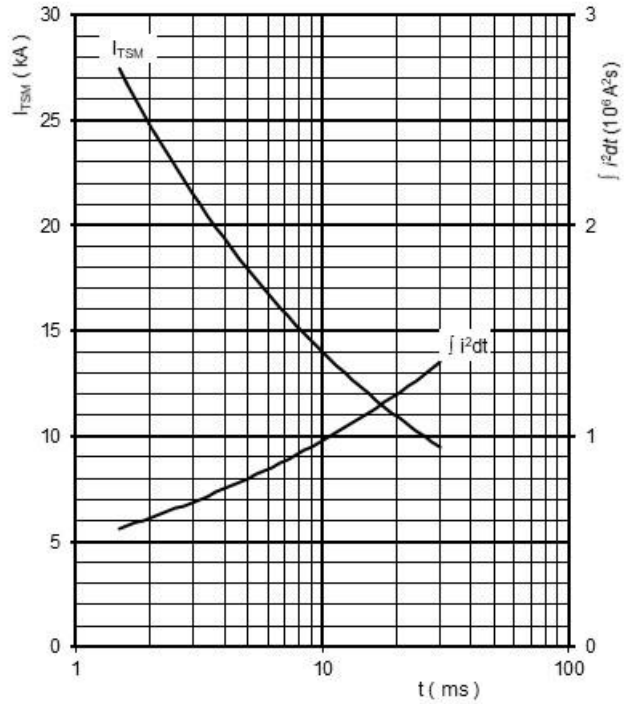


Fig. 4 Surge on-state current vs. pulse length, half sine wave, single pulse,  $V_D = V_R = 0 \text{ V}$ ,  $T_j = T_{jmax}$

**Gate trigger characteristics**

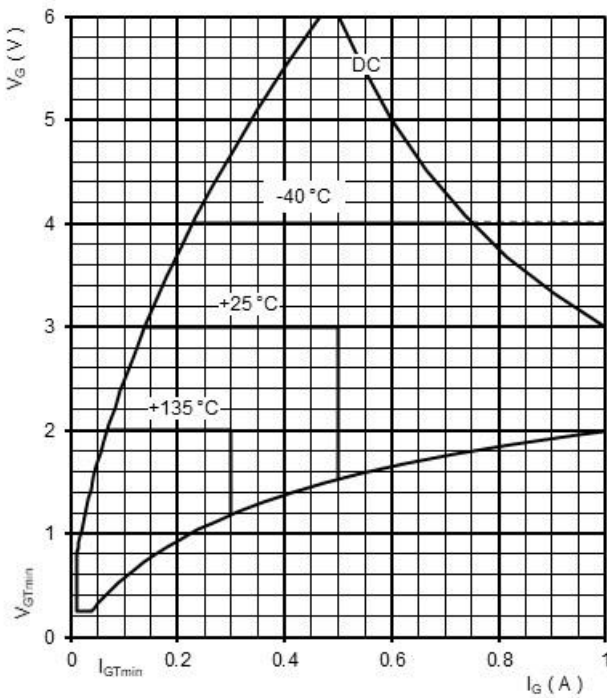


Fig. 5 Gate trigger characteristics

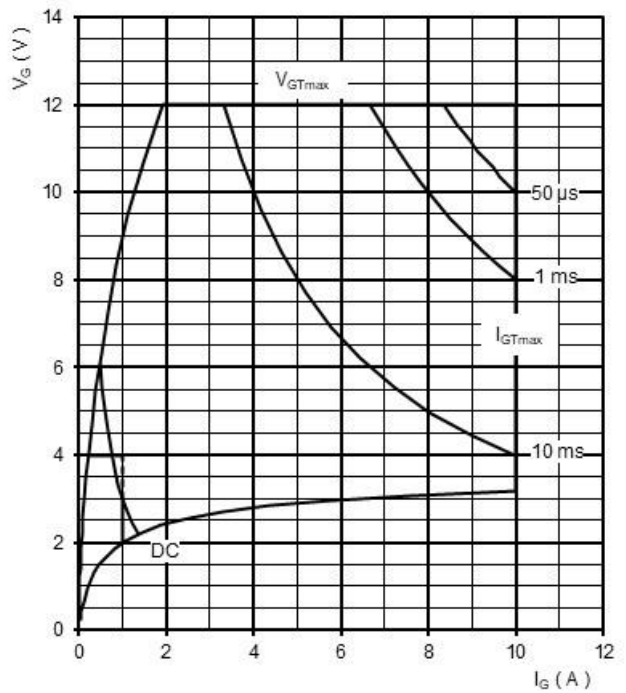


Fig. 6 Maximum peak gate power loss

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Power loss and maximum case temperature characteristics per arm

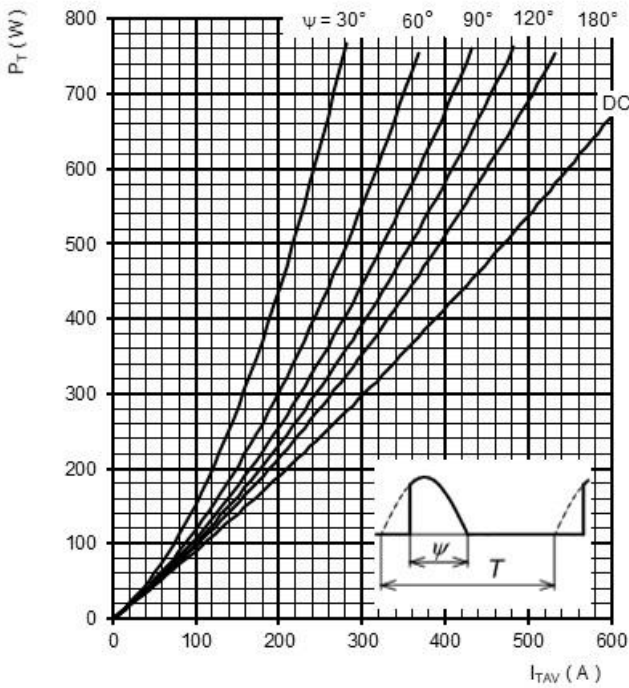


Fig. 7 On-state power loss vs. average on-state current, sine waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

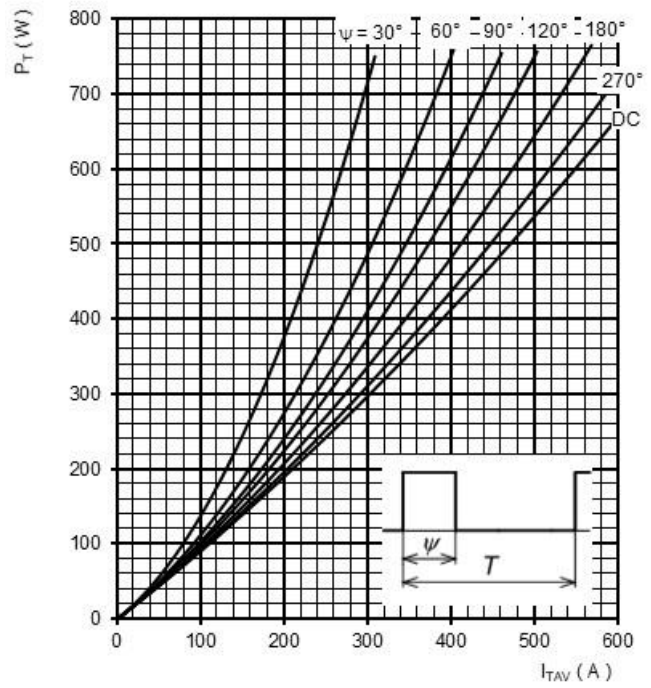


Fig. 8 On-state power loss vs. average on-state current, square waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

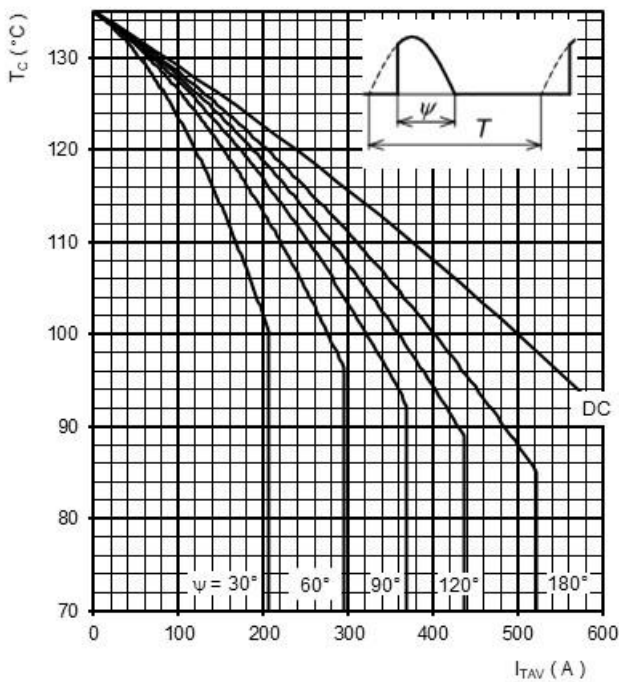


Fig. 9 Max. case temperature vs. aver. on-state current, sine waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

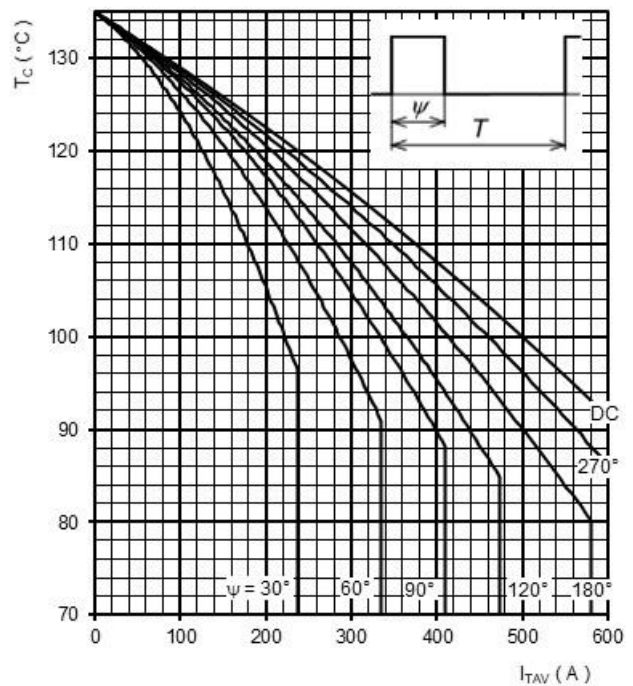


Fig. 10 Max. case temperature vs. aver. on-state current, square waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

Note: Figures number 7 ÷ 10 have been calculated without considering any turn-on and turn-off losses. They are valid for  $f = 50$  or  $60 \text{ Hz}$  operation.

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